

RoHS Compliant Product
 A suffix of "-C" specifies halogen free

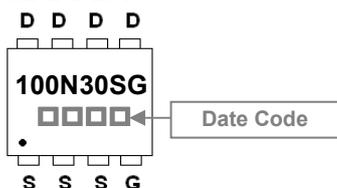
DESCRIPTION

The SPR100N30SG is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent R_{DS(ON)} and gate charge for most of the synchronous buck converter applications. The SPR100N30SG meet the RoHS and Green Product with Function reliability approved.

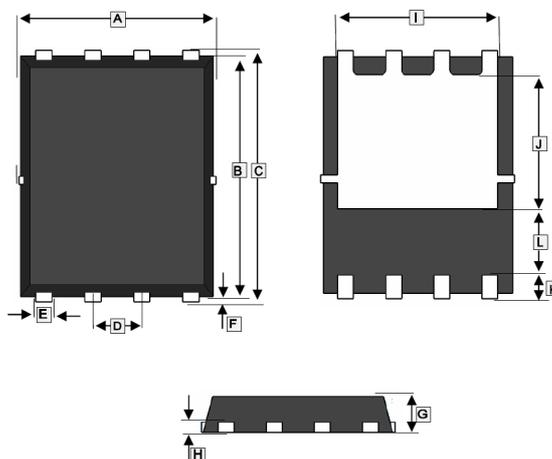
FEATURES

- R_{DS(on)} ≤ 2.1mΩ @V_{GS}=10V
- R_{DS(on)} ≤ 3.3mΩ @V_{GS}=4.5V
- High speed power switching, Logic Level
- Enhanced Avalanche Ruggedness
- 100% UIS Tested, 100% Rg Tested
- PR-8PP Package

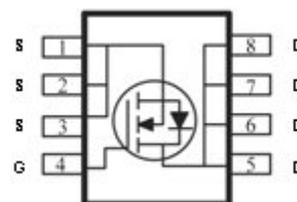
MARKING



PR-8PP



| REF. | Millimeter | | REF. | Millimeter | |
|------|------------|------|------|------------|------|
| | Min. | Max. | | Min. | Max. |
| A | 4.9 | 5.1 | G | 0.8 | 1.0 |
| B | 5.7 | 5.9 | H | 0.254 | Ref. |
| C | 5.95 | 6.2 | I | 4.0 | Ref. |
| D | 1.27 BSC. | | J | 3.4 | Ref. |
| E | 0.35 | 0.49 | K | 0.6 | Ref. |
| F | 0.1 | 0.2 | L | 1.4 | Ref. |



PACKAGE INFORMATION

| Package | MPQ | Leader Size |
|---------|-----|-------------|
| PR-8PP | 3K | 13 inch |

ABSOLUTE MAXIMUM RATINGS (T_J=25°C unless otherwise specified)

| Parameter | Symbol | Ratings | Unit |
|--|-----------------------------------|-----------------------|--------|
| Drain-Source Voltage | V _{DS} | 30 | V |
| Gate-Source Voltage | V _{GS} | ±20 | V |
| Continuous Drain Current (Silicon Limited) | I _D | T _C =25°C | 100 |
| | | T _C =100°C | 75 |
| Pulsed Drain Current | I _{DM} | 400 | A |
| Avalanche Energy, Single Pulse, @L=0.1mH | E _{AS} | 211 | mJ |
| Power Dissipation | P _D | 50 | W |
| Operating Junction and Storage Temperature Range | T _J , T _{STG} | -55 ~ 150 | °C |
| Thermal Resistance Ratings | | | |
| Maximum Thermal Resistance Junction-Ambient | R _{θJA} | 50 | °C / W |
| Maximum Thermal Resistance Junction-Case | R _{θJC} | 2.5 | |

ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test conditions | |
|-----------------------------------|--------------|-------------------------|------|-----------|------------|--|-------------------------------|
| Drain-Source Breakdown Voltage | BV_{DSS} | 30 | - | - | V | $V_{GS}=0, I_D=250\mu\text{A}$ | |
| Gate Threshold Voltage | $V_{GS(th)}$ | 1 | 1.5 | 3 | V | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$ | |
| Forward Transfer conductance | g_{fs} | - | 70 | - | S | $V_{DS}=5\text{V}, I_D=25\text{A}$ | |
| Gate-Source Leakage Current | I_{GSS} | - | - | ± 100 | nA | $V_{GS}=\pm 20\text{V}$ | |
| Drain-Source Leakage Current | I_{DSS} | $T_J=25^\circ\text{C}$ | - | - | 1 | μA | $V_{DS}=24\text{V}, V_{GS}=0$ |
| | | $T_J=125^\circ\text{C}$ | - | - | 25 | | $V_{DS}=20\text{V}, V_{GS}=0$ |
| Static Drain-Source On-Resistance | $R_{DS(ON)}$ | - | 1.8 | 2.1 | m Ω | $V_{GS}=10\text{V}, I_D=25\text{A}$ | |
| | | - | 2.7 | 3.3 | m Ω | $V_{GS}=4.5\text{V}, I_D=15\text{A}$ | |
| Total Gate Charge | Q_g | - | 59 | - | nC | $V_{GS}=10\text{V}$ | |
| Total Gate Charge | Q_g | - | 28 | - | | $V_{GS}=4.5\text{V}$ | |
| Gate-Source Charge | Q_{gs} | - | 13 | - | | $I_D=25\text{A}$ | |
| Gate-Drain ("Miller") Charge | Q_{gd} | - | 11 | - | | $V_{DD}=15\text{V}$ $V_{GS}=10\text{V}$ | |
| Turn-on Delay Time | $T_{d(on)}$ | - | 25 | - | nS | $V_{DD}=15\text{V}$ $I_D=1\text{A}$ $V_{GS}=10\text{V}$ $R_G=2.7\Omega$ | |
| Rise Time | T_r | - | 16 | - | | | |
| Turn-off Delay Time | $T_{d(off)}$ | - | 60 | - | | | |
| Fall Time | T_f | - | 25 | - | | | |
| Input Capacitance | C_{iss} | - | 3813 | - | pF | $V_{GS}=0$ $V_{DS}=15\text{V}$ $f=1.0\text{MHz}$ | |
| Output Capacitance | C_{oss} | - | 540 | - | | | |
| Reverse Transfer Capacitance | C_{rss} | - | 440 | - | | | |
| Source-Drain Diode | | | | | | | |
| Forward On Voltage | V_{SD} | - | - | 1.2 | V | $I_F=30\text{A}, V_{GS}=0$ | |
| Reverse Recovery Time | T_{rr} | - | 35 | - | nS | $I_F=100\text{A}, di/dt=100\text{A}/\mu\text{s}$ | |
| Reverse Recovery Charge | Q_{rr} | - | 25 | - | nC | | |

TYPICAL CHARACTERISTICS CURVE

Fig 1. Typical Output Characteristics

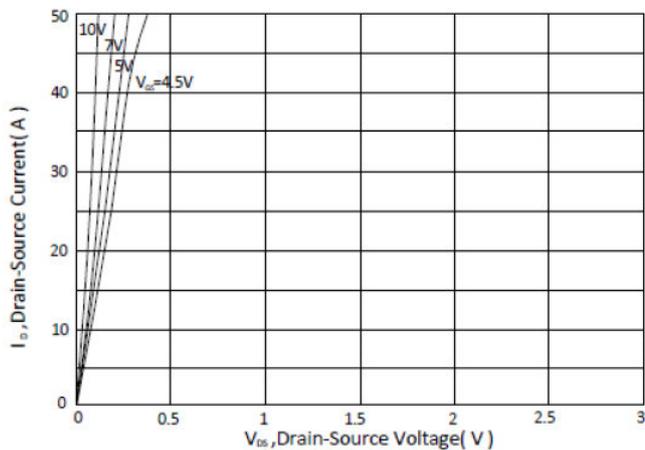


Figure 2. On-Resistance vs. Gate-Source Voltage

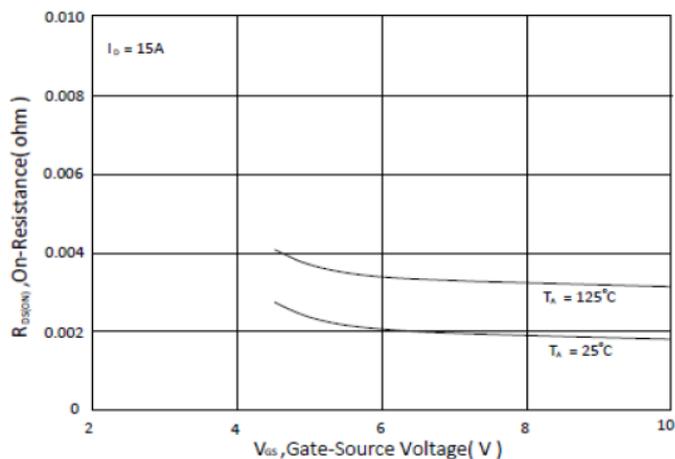


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

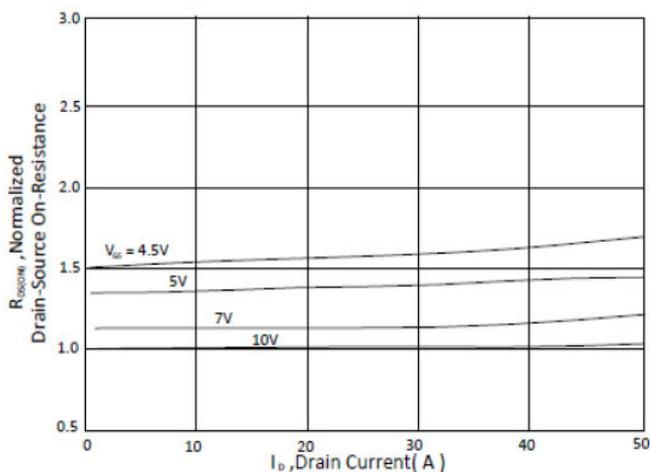


Figure 4. Normalized On-Resistance vs. Junction Temperature

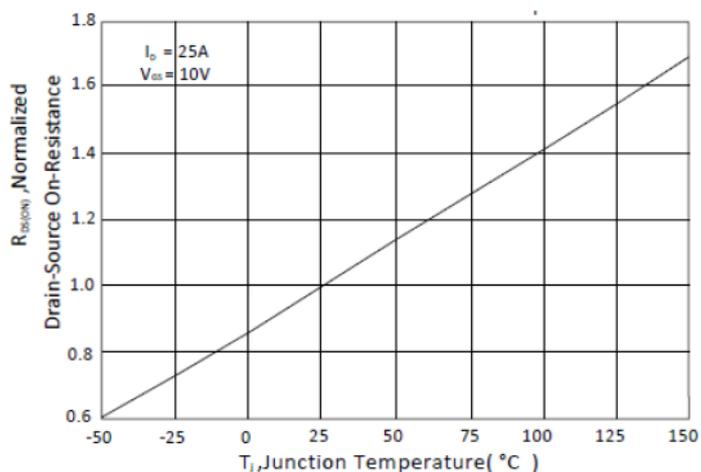


Figure 5. Typical Transfer Characteristics

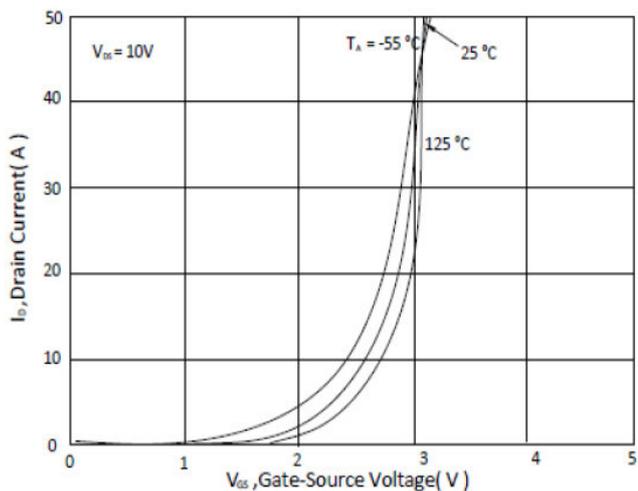


Figure 6. Typical Source-Drain Diode Forward Voltage

